

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Attorney Docket No. 040679/0439

Applicant:

Haruhiko MURATA et al.

Title:

IMPROVEMENT IN OR RELATING TO CIRCUIT BOARD

HAVING SOLDER BUMPS

Serial No.:

08/825,400

Filed:

March 28, 1997

Examiner:

Norris, Jeremy C.

Art Unit:

2827

AMENDMENT AND REPLY UNDER 37 C.F.R. § 1.111

Commissioner for Patents Washington, D.C. 20231

Sir:

In reply to the Office Action dated November 20, 2002, please amend the above-identified patent application as follows.

This Amendment and Reply is being filed in accordance with the Notification of Requested New Format for Amendments and/or Responses Filed in Art Units 1634, 2827, and 2834, dated December 20, 2002.